

# HiPerFET™ Power MOSFETs

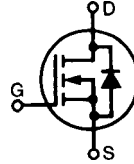
**IXFK72N20**  
**IXFK80N20**

$V_{DSS}$	$I_{D25}$	$R_{DS(on)}$
<b>200 V</b>	<b>72 A</b>	<b>35 mΩ</b>
<b>200 V</b>	<b>80 A</b>	<b>30 mΩ</b>

**$t_{rr} \leq 200$  ns**

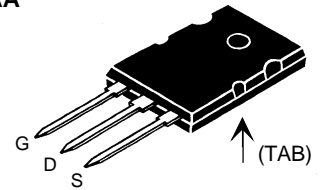
N-Channel Enhancement Mode  
Avalanche Rated, High dv/dt, Low  $t_{rr}$

Preliminary data



Symbol	Test Conditions	Maximum Ratings	
$V_{DSS}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$	200	V
$V_{DGR}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ ; $R_{GS} = 1$ MΩ	200	V
$V_{GS}$	Continuous	±20	V
$V_{GSM}$	Transient	±30	V
$I_{D25}$	$T_C = 25^\circ\text{C}$	72N20	72 A
		80N20	80 A
$I_{DM}$	$T_C = 25^\circ\text{C}$ , pulse width limited by $T_{JM}$	72N20	288 A
		80N20	320 A
$I_{AR}$	$T_C = 25^\circ\text{C}$	74	A
$E_{AR}$	$T_C = 25^\circ\text{C}$	45	mJ
<b>dv/dt</b>	$I_S \leq I_{DM}$ , $di/dt \leq 100$ A/μs, $V_{DD} \leq V_{DSS}$ , $T_J \leq 150^\circ\text{C}$ , $R_G = 2$ Ω	5	V/ns
$P_D$	$T_C = 25^\circ\text{C}$	360	W
$T_J$		-55 ... +150	°C
$T_{JM}$		150	°C
$T_{stg}$		-55 ... +150	°C
$T_L$	1.6 mm (0.063 in) from case for 10 s	300 -	°C
$M_d$	Mounting torque	0.9/6	Nm/lb.in.
<b>Weight</b>		10	g

TO-264 AA



G = Gate  
S = Source

D = Drain  
TAB = Drain

## Features

- International standard packages
- Molding epoxies meet UL94 V-0 flammability classification
- Low  $R_{DS(on)}$  HDMOS™ process
- Unclamped Inductive Switching (UIS) rated
- Fast intrinsic rectifier

## Applications

- DC-DC converters
- Synchronous rectification
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- Temperature and lighting controls

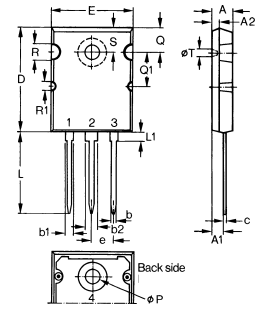
## Advantages

- Easy to mount
- Space savings
- High power density

Symbol	Test Conditions	Characteristic Values ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)		
		min.	typ.	max.
$V_{DSS}$	$V_{GS} = 0$ V, $I_D = 1$ mA	200		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 4$ mA	2		V
$I_{GSS}$	$V_{GS} = \pm 20$ V <sub>DC</sub> , $V_{DS} = 0$			±100 nA
$I_{DSS}$	$V_{DS} = 0.8 \cdot V_{DSS}$ $V_{GS} = 0$ V	$T_J = 25^\circ\text{C}$		200 μA
		$T_J = 125^\circ\text{C}$		1 mA
$R_{DS(on)}$	$V_{GS} = 10$ V, $I_D = 0.5 \cdot I_{D25}$  Pulse test, $t \leq 300$ μs, duty cycle $d \leq 2$ %	72N20		35 mΩ
		80N20		30 mΩ

Symbol	Test Conditions	Characteristic Values ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)		
		min.	typ.	max.
$g_{fs}$	$V_{DS} = 10\text{ V}; I_D = 0.5 \cdot I_{D25}$ , pulse test	35	42	S
$C_{iss}$	$V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$		5900	pF
$C_{oss}$			1140	pF
$C_{rss}$			480	pF
$t_{d(on)}$	$V_{GS} = 10\text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 \cdot I_{D25}$ $R_G = \text{(External)}$		40	ns
$t_r$			55	ns
$t_{d(off)}$			120	ns
$t_f$			26	ns
$Q_{g(on)}$	$V_{GS} = 10\text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 \cdot I_{D25}$		280	nC
$Q_{gs}$			39	nC
$Q_{gd}$			120	nC
$R_{thJC}$			0.35	K/W
$R_{thCK}$			0.15	K/W

Symbol	Test Conditions	Characteristic Values ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)		
		min.	typ.	max.
$I_S$	$V_{GS} = 0\text{ V}$	72N20 80N20		72 A 80 A
$I_{SM}$	Repetitive; pulse width limited by $T_{JM}$	72N20 80N20		288 A 320 A
$V_{SD}$	$I_F = I_S, V_{GS} = 0\text{ V}$ , Pulse test, $t \leq 300\ \mu\text{s}$ , duty cycle $d \leq 2\%$			1.5 V
$t_{rr}$	$I_F = I_S, -di/dt = 100\text{ A}/\mu\text{s}, V_R = 100\text{ V}$		1.2	200 ns
$Q_{RM}$			10	$\mu\text{C}$
$I_{RM}$				A

**TO-264 AA Outline**


Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.82	5.13	.190	.202
A1	2.54	2.89	.100	.114
A2	2.00	2.10	.079	.083
b	1.12	1.42	.044	.056
b1	2.39	2.69	.094	.106
b2	2.90	3.09	.114	.122
c	0.53	0.83	.021	.033
D	25.91	26.16	1.020	1.030
E	19.81	19.96	.780	.786
e	5.46	BSC	.215	BSC
J	0.00	0.25	.000	.010
K	0.00	0.25	.000	.010
L	20.32	20.83	.800	.820
L1	2.29	2.59	.090	.102
P	3.17	3.66	.125	.144
Q	6.07	6.27	.239	.247
Q1	8.38	8.69	.330	.342
R	3.81	4.32	.150	.170
R1	1.78	2.29	.070	.090
S	6.04	6.30	.238	.248
T	1.57	1.83	.062	.072

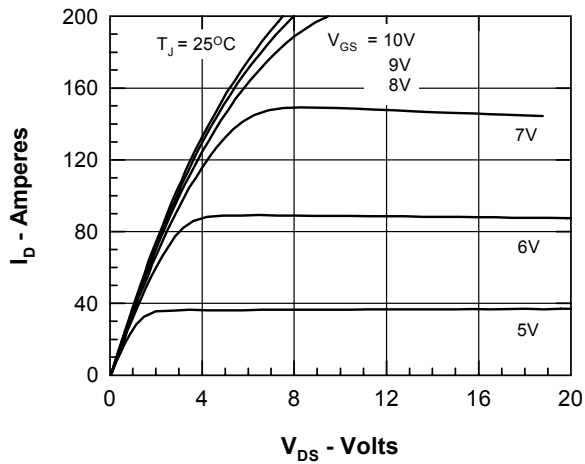


Figure 1. Output Characteristics at 25°C

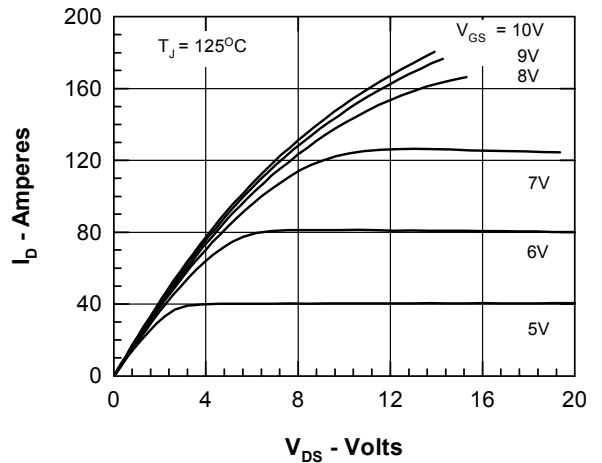


Figure 2. Output Characteristics at 125°C

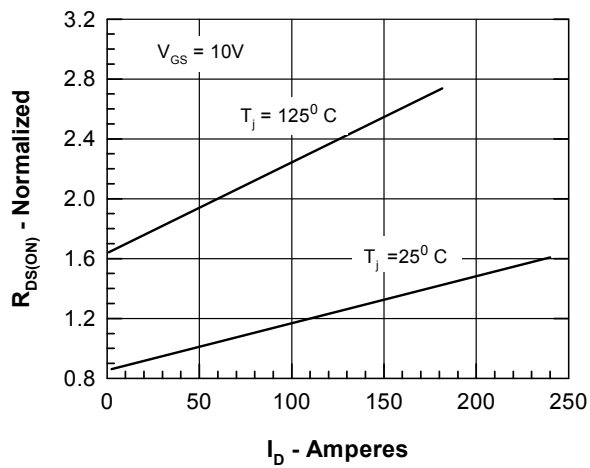


Figure 3.  $R_{DS(on)}$  normalized to  $0.5 I_{D25}$  value

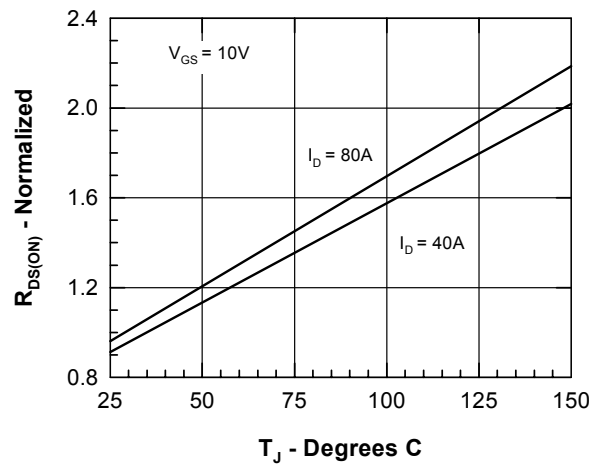


Figure 4.  $R_{DS(on)}$  normalized to  $0.5 I_{D25}$  value

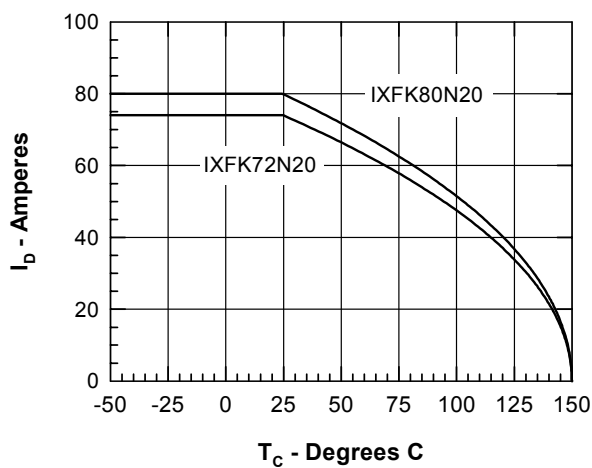


Figure 5. Drain Current vs. Case Temperature

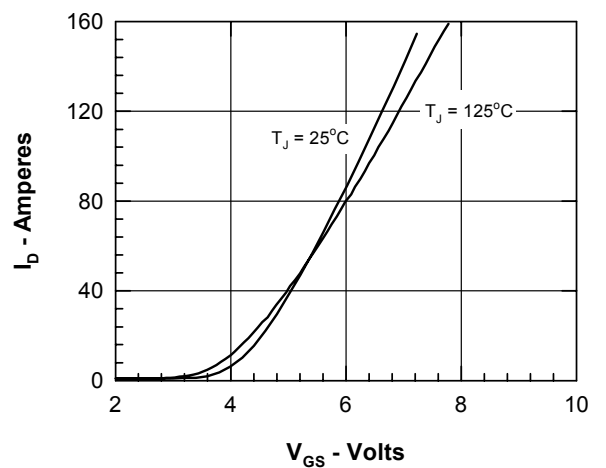


Figure 6. Admittance Curves

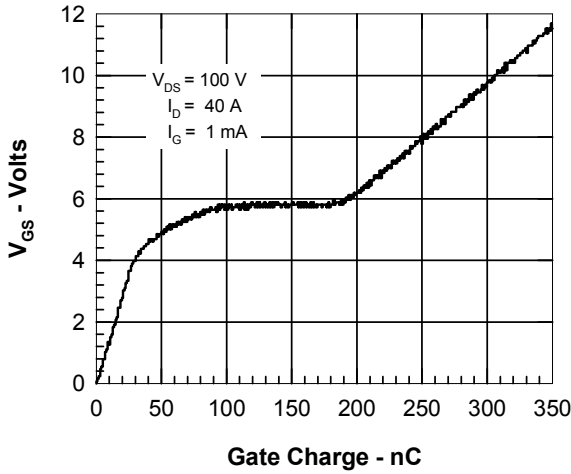


Figure 7. Gate Charge

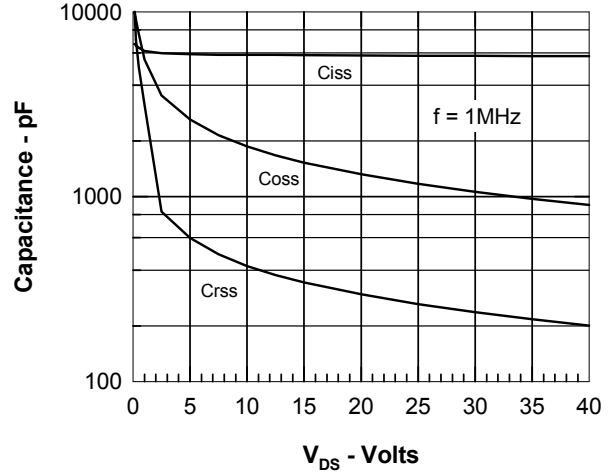


Figure 8. Capacitance Curves

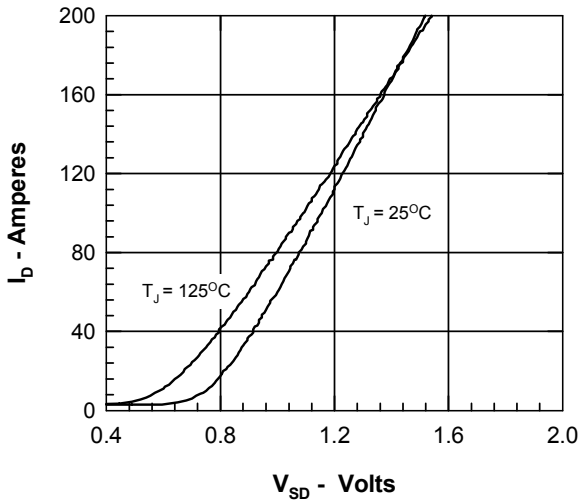


Figure 9. Source Current vs. Source to Drain Voltage

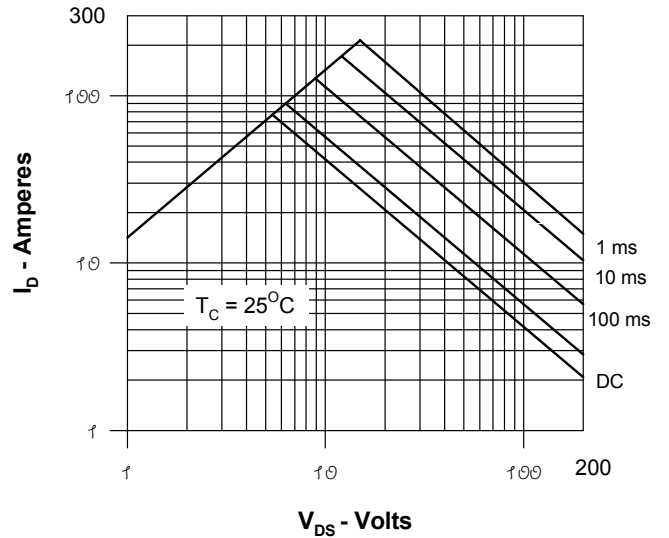


Figure 10. Forward Bias Safe Operating Area

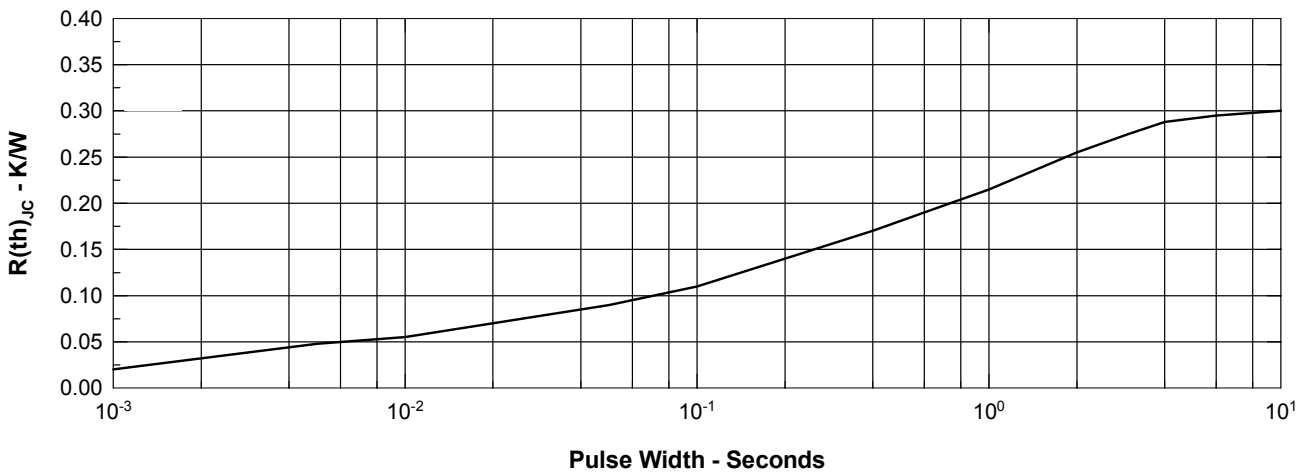


Figure 11. Transient Thermal Resistance